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FDD6670A

March 2015



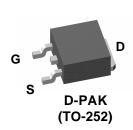
30V N-Channel PowerTrench^o MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$, fast switching speed and extremely low $R_{DS(ON)}$ in a small package.

Applications

- DC/DC converter
- Motor Drives

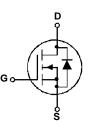


Features

• 66 A, 30 V
$$R_{DS(ON)} = 8 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$$

 $R_{DS(ON)} = 10 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$

- Low gate charge
- Fast Switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



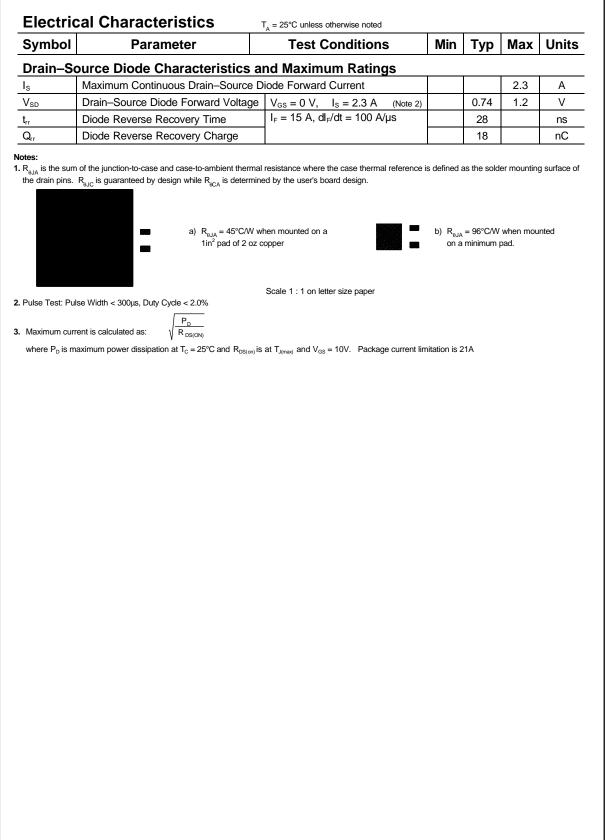
Absolute Maximum Ratings T_A=25°C unless otherwise noted

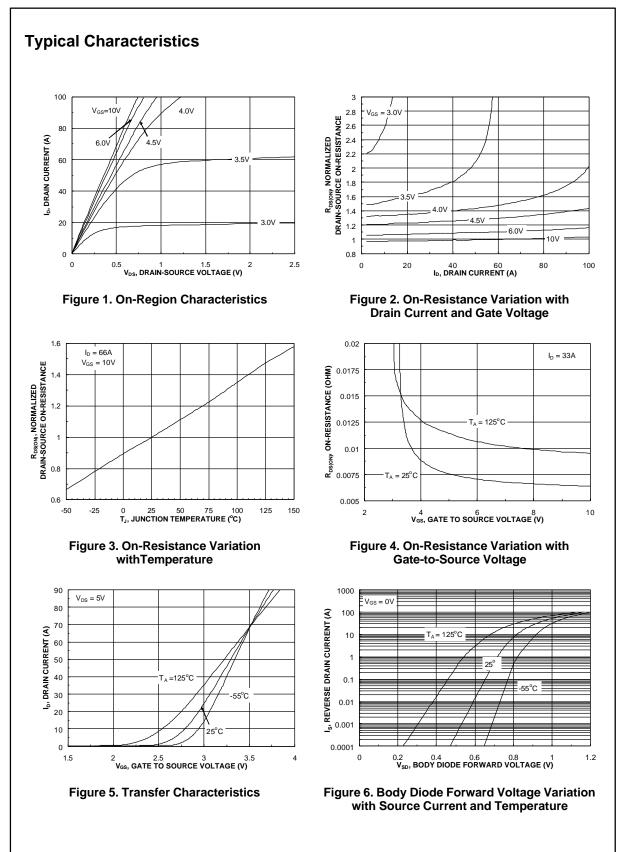
Symbol	Parameter			Ratings		I	Units		
V _{DSS}	Drain-Source Voltag	ge				30		V	
V _{GSS}	Gate-Source Voltag	je				±20		V	
D	Continuous Drain C	urrent @T _c =25	°C	(Note 3)		66		А	
		@T _A =25°	°C	(Note 1a)		15			
		Pulsed		(Note 1a)		100			
P _D	Power Dissipation	@T _c =25	°C	(Note 3)		63	W		
	@T _A =		°C	(Note 1a)	3.2				
		@T _A =25°	°C	(Note 1b)		1.3			
Tj, T _{stg}	Operating and Storage Junction Temperature Range				-55 to +175			°C	
Therma	I Characterist	ics							
R _{eJC}	Thermal Resistance, Junction-to-Case		ase	(Note 1)	2.4			°C/W	
$R_{\theta JA}$	Thermal Resistance	e, Junction-to-An	tion-to-Ambient		40				
R _{eja}	-			(Note 1b)	96				
Packag	e Marking and	d Ordering	Infor	mation					
Device	Marking	Device	e Package		Reel Size	Tape width Qua		ntity	
FDD6	670A FI	DD6670A	D-PAK (TO-252)		13"	16mm		2500 units	

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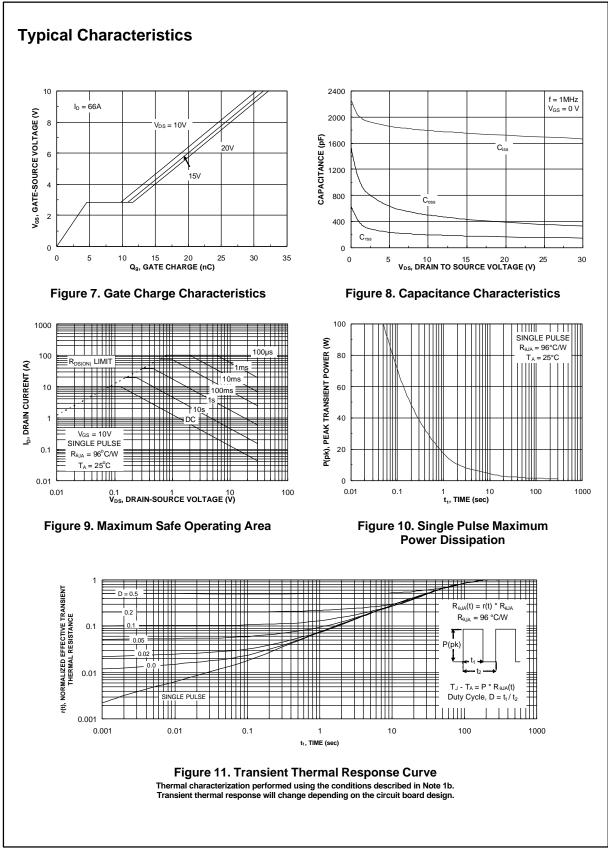
	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-Sc	ource Avalanche Ratings (No	te 2)				
E AS	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_D = 66 \text{ A}$			67	mJ
AS	Drain-Source Avalanche Current				66	Α
Off Char	racteristics	•				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
	Breakdown Voltage Temperature	$I_{\rm D} = 250 \ \mu$ A,Referenced to 25°C		26		mV/°C
$\Delta T_{\rm J}$	Coefficient					, c
DSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μΑ
GSS	Gate–Body Leakage	$V_{\text{GS}} = \pm 20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	1.8	3	V
	Gate Threshold Voltage	$I_D = 250 \ \mu$ A,Referenced to 25° C		-5		mV/°C
ΔT_{J}	Temperature Coefficient			0.0		
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 13 \text{ A}$		6.3 7.9	8 10	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}, T_J = 125^{\circ}\text{C}$		9.5	13	
D(on)	On-State Drain Current	$V_{\text{GS}} = 10 \text{ V}, \qquad V_{\text{DS}} = 5 \text{ V}$	50			Α
FS	Forward Transconductance	$V_{\text{DS}} = 10 \text{ V}, \qquad I_{\text{D}} = 15 \text{ A}$		60		S
Dvnamio	c Characteristics					
iss	Input Capacitance			1755		pF
Soss	Output Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		430		pF
Srss	Reverse Transfer Capacitance	f = 1.0 MHz		180		pF
R _G	Gate Resistance	V _{GS} = 15 mV, f = 1.0 MHz		1.3		Ω
		•				
Switchir					00	-
	ng Characteristics (Note 2)			11	20	
d(on)	Turn–On Delay Time	V ₂₂ = 15 V l ₂ = 1 A		11 12	20 21	ns ns
d(on) r	Turn–On Delay Time Turn–On Rise Time	$V_{DD} = 15 \text{ V}, I_D = 1 \text{ A},$ $V_{CS} = 10 \text{ V}, \text{R}_{CEV} = 6 \Omega$		12	21	ns
d(on) d(off)	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	$\label{eq:V_DD} \begin{array}{ll} V_{\text{DD}} = 15 \ V, & I_{\text{D}} = 1 \ A, \\ V_{\text{GS}} = 10 \ V, & R_{\text{GEN}} = 6 \ \Omega \end{array}$		12 29	21 47	ns ns
d(on) r d(off)	Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time			12	21	ns ns ns
Switchir	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time			12 29 19	21 47 34	ns ns

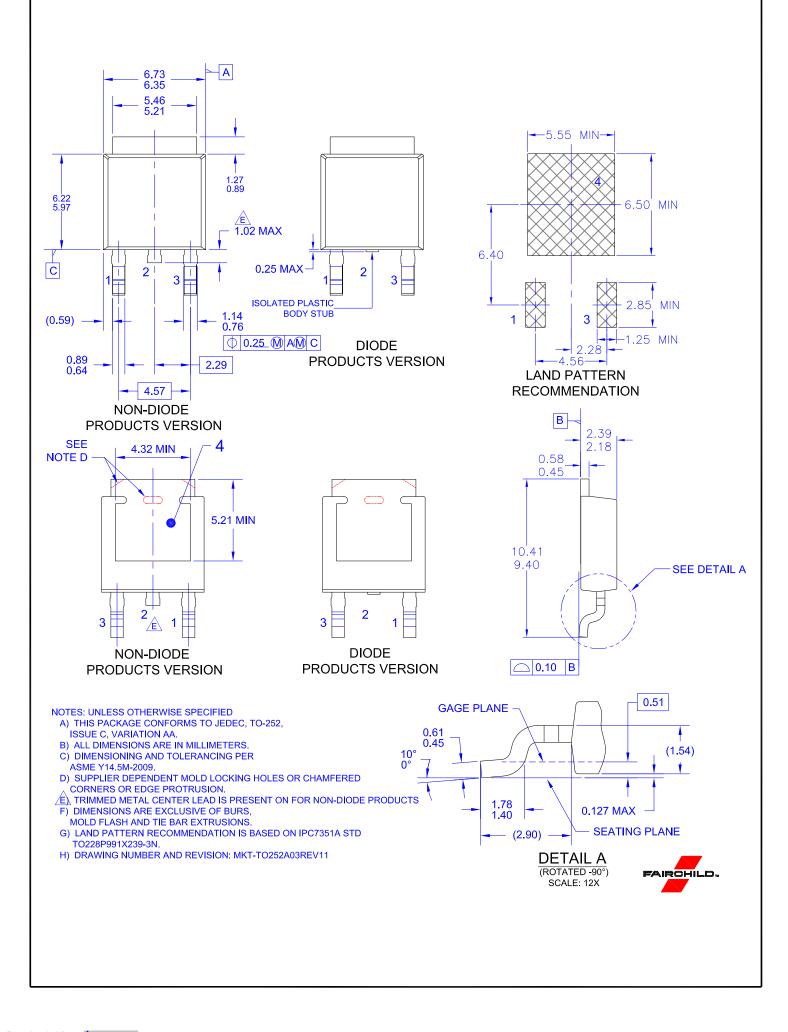
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